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Kind regards,

Team Nexperia

74AUP1G0832

Low-power 3-input AND-OR gate Rev. 5 — 22 June 2012

Product data sheet

General description 1.

The 74AUP1G0832 provides the Boolean function: $Y = (A \times B) + C$. The user can choose the logic functions OR, AND and AND-OR. All inputs can be connected to V_{CC} or GND.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Features and benefits 2.

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - ◆ JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \,\mu\text{A}$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | | | | |
|---------------|-------------------|-------|---|---------|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | |
| 74AUP1G0832GW | –40 °C to +125 °C | SC-88 | plastic surface-mounted package; 6 leads | SOT363 | | | | | |
| 74AUP1G0832GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 | | | | | |
| 74AUP1G0832GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm | SOT891 | | | | | |
| 74AUP1G0832GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 | | | | | |
| 74AUP1G0832GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body 1.0 \times 1.0 \times 0.35 mm | SOT1202 | | | | | |

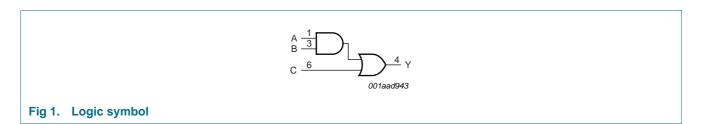
4. Marking

Table 2. Marking

| Type number | Marking code ^[1] |
|---------------|-----------------------------|
| 74AUP1G0832GW | aY |
| 74AUP1G0832GM | aY |
| 74AUP1G0832GF | aY |
| 74AUP1G0832GN | aY |
| 74AUP1G0832GS | aY |

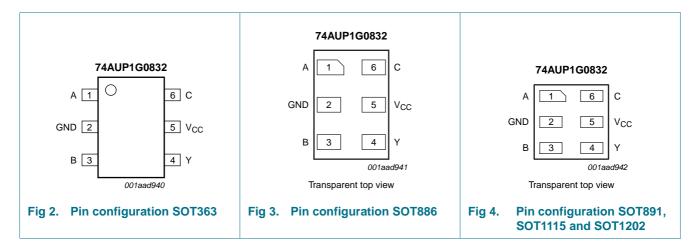
^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Description |
|-----------------|-----|----------------|
| Α | 1 | data input A |
| GND | 2 | ground (0 V) |
| В | 3 | data input B |
| Υ | 4 | data output Y |
| V _{CC} | 5 | supply voltage |
| С | 6 | data input C |

7. Functional description

Table 4. Function table[1]

| Input | | | Output |
|-------|---|---|--------|
| С | В | Α | Υ |
| L | L | L | L |
| L | L | Н | L |
| L | Н | L | L |
| L | Н | Н | Н |
| Н | L | L | Н |
| Н | L | Н | Н |
| Н | Н | L | Н |
| Н | Н | Н | Н |

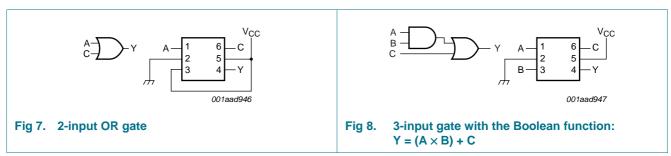
^[1] H = HIGH voltage level; L = LOW voltage level.

7.1 Logic configurations

Table 5. Function selection table

| Logic function | Figure |
|--|--------------------|
| 2-input AND | see Figure 5 |
| 2-input OR | see Figure 6 and 7 |
| 3-input gate with the Boolean function: $Y = (A \times B) + C$ | see Figure 8 |





8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-----------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +4.6 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +4.6 | V |
| I _{OK} | output clamping current | V _O < 0 V | -50 | - | mA |
| V _O | output voltage | Active mode and Power-down mode | <u>[1]</u> –0.5 | +4.6 | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±20 | mA |
| I _{CC} | supply current | | - | 50 | mA |
| I_{GND} | ground current | | -50 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$ | [2] _ | 250 | mW |

- [1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- [2] For SC-88 packages: above 87.5 $^{\circ}$ C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 packages: above 118 $^{\circ}$ C the value of P_{tot} derates linearly with 7.8 mW/K.

74AUP1G0832

9. Recommended operating conditions

Table 7. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------------------|--|-----|----------|------|
| V_{CC} | supply voltage | | 0.8 | 3.6 | V |
| VI | input voltage | | 0 | 3.6 | V |
| Vo | output voltage | Active mode | 0 | V_{CC} | V |
| | | Power-down mode; V _{CC} = 0 V | 0 | 3.6 | V |
| T_{amb} | ambient temperature | | -40 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ | 0 | 200 | ns/V |

10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------|--|-----------------------|-----|---------------------------|-------------|
| T _{amb} = 25 | 5 °C | | | | | |
| V_{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.70 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 0.8 V | - | - | $0.30 \times V_{CC}$ | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V | V _{CC} - 0.1 | - | - | V |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.75 \times V_{CC}$ | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.11 | - | - | V |
| | | $I_O = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.32 | - | - | V |
| | | $I_O = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 2.05 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.72 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.6 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | $0.3 \times V_{CC}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.44 | V |
| | | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.31 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.44 | V |
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 Table 8.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit | |
|----------------------|--------------------------------------|--|-----------------------|-----|----------------------|------|--|
| l _l | input leakage current | $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V | - | - | ±0.1 | μΑ | |
| l _{OFF} | power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.2 | μΑ | |
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | V to 0.2 V | | | | |
| cc | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.5 | μΑ | |
| Δl _{CC} | additional supply current | $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | [1] - | - | 40 | μΑ | |
| Cı | input capacitance | $V_{CC} = 0 \text{ V to } 3.6 \text{ V}; V_{I} = \text{GND or } V_{CC}$ | - | 0.8 | - | pF | |
| Co | output capacitance | $V_O = GND; V_{CC} = 0 V$ | - | 1.7 | - | pF | |
| Г _{ать} = - | 40 °C to +85 °C | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 0.8 V | $0.70 \times V_{CC}$ | - | - | V | |
| | | $V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$ | $0.65 \times V_{CC}$ | - | - | V | |
| | | V_{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V | |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2.0 | - | - | V | |
| V _{IL} | LOW-level input voltage | V _{CC} = 0.8 V | - | - | $0.30 \times V_{CC}$ | V | |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V | |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V | |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | - | - | 0.9 | V | |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | |
| | | $I_O = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V | V _{CC} - 0.1 | - | - | V | |
| | | $I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | $0.7 \times V_{CC}$ | - | - | V | |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | 1.03 | - | - | V | |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.30 | - | - | V | |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.97 | - | - | V | |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.85 | - | - | V | |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.67 | - | - | V | |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.55 | - | - | V | |
| V _{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | |
| | | I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V | |
| | | $I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | - | - | $0.3 \times V_{CC}$ | V | |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | - | - | 0.37 | V | |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.35 | V | |
| | | $I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.33 | V | |
| | | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V | |
| | | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.33 | V | |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.45 | V | |
| | input leakage current | $V_1 = GND \text{ to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$ | - | - | ±0.5 | μΑ | |
| OFF | power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V | - | - | ±0.5 | μA | |
| ΔI_{OFF} | additional power-off leakage current | V ₁ or V _O = 0 V to 3.6 V; V _{CC} = 0 V to 0.2 V | - | - | ±0.6 | μΑ | |

74AUP1G083

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 Table 8.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------|--------------------------------------|--|------------|------------------------|-----|-----------------------------|------|
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | | - | - | 0.9 | μΑ |
| Δl _{CC} | additional supply current | $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | <u>[1]</u> | - | - | 50 | μΑ |
| T _{amb} = - | 40 °C to +125 °C | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 0.8 \text{ V}$ | | $0.75 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | | $0.70 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | V _{CC} = 0.8 V | | - | - | $0.25 \times V_{CC}$ | V |
| | | V _{CC} = 0.9 V to 1.95 V | | - | - | $0.30 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | - | 0.7 | V |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | - | - | 0.9 | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | |
| | | $I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V | | V _{CC} - 0.11 | - | - | V |
| | | $I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ | | $0.6 \times V_{CC}$ | - | - | V |
| | | $I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | | 0.93 | - | - | V |
| | | $I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | | 1.17 | - | - | V |
| | | $I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | | 1.77 | - | - | V |
| | | $I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | | 1.67 | - | - | V |
| | | $I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | | 2.40 | - | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | | 2.30 | - | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | |
| | | $I_O = 20 \mu\text{A}; V_{CC} = 0.8 \text{V} \text{to} 3.6 \text{V}$ | | - | - | 0.11 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | | - | - | $0.33 \times V_{\text{CC}}$ | V |
| | | $I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ | | - | - | 0.41 | V |
| | | $I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | | - | - | 0.39 | V |
| | | $I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | | - | - | 0.36 | V |
| | | $I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | | - | - | 0.50 | V |
| | | $I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | | - | - | 0.36 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | | - | - | 0.50 | V |
| I _I | input leakage current | $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V | | - | - | ±0.75 | μΑ |
| I _{OFF} | power-off leakage current | V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V | | - | - | ±0.75 | μΑ |
| ΔI_{OFF} | additional power-off leakage current | V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V | | - | - | ±0.75 | μΑ |
| I _{CC} | supply current | V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V | | - | - | 1.4 | μΑ |
| ΔI_{CC} | additional supply current | $V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$ | [1] | - | - | 75 | μΑ |

^[1] One input at V_{CC} – 0.6 V, other input at V_{CC} or GND.

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

| Symbol | Parameter | Conditions | | | 25 °C | | -40 | Unit | | |
|---------------------|-------------------|--|-----|-----|--------|------|-----|----------------|-----------------|----|
| | | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | |
| $C_L = 5 p$ | F | | ľ | | | | | | | |
| t _{pd} | propagation delay | A, B or C to Y; see Figure 9 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 19.5 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 2.5 | 5.6 | 11.1 | 2.2 | 11.3 | 12.4 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 1.9 | 3.9 | 6.4 | 2.0 | 6.9 | 7.6 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.6 | 3.1 | 5.1 | 1.5 | 5.7 | 6.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.4 | 2.4 | 3.7 | 1.3 | 4.2 | 4.6 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.3 | 2.2 | 3.2 | 1.2 | 3.5 | 3.9 | ns |
| C _L = 10 | pF | | | | | | | | | |
| t_{pd} | propagation delay | A, B or C to Y; see Figure 9 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 23.1 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 2.8 | 6.5 | 12.7 | 2.5 | 12.9 | 14.2 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 2.2 | 4.5 | 7.4 | 2.3 | 8.0 | 8.8 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 2.0 | 3.7 | 5.9 | 1.8 | 6.6 | 7.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.8 | 3.0 | 4.4 | 1.6 | 4.9 | 5.4 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.6 | 2.7 | 3.9 | 1.5 | 4.2 | 4.6 | ns |
| C _L = 15 | pF | | | | | | | | | |
| t_{pd} | propagation delay | A, B or C to Y; see Figure 9 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 26.6 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 3.2 | 7.3 | 14.2 | 2.8 | 14.7 | 16.2 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 2.5 | 5.1 | 8.3 | 2.6 | 9.1 | 10.0 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 2.3 | 4.2 | 6.7 | 2.0 | 7.5 | 8.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 2.1 | 3.4 | 5.0 | 1.9 | 5.6 | 6.2 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.9 | 3.2 | 4.5 | 1.8 | 4.8 | 5.3 | ns |
| C _L = 30 | pF | | | | | | | | | |
| t_{pd} | propagation delay | A, B or C to Y; see Figure 9 | [2] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 34.8 | - | - | - | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | 4.1 | 9.5 | 19.0 | 3.6 | 19.8 | 21.8 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | 3.3 | 6.6 | 11.0 | 3.3 | 12.1 | 13.3 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 3.0 | 5.5 | 8.8 | 2.6 | 10.0 | 11.0 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2.8 | 4.5 | 6.6 | 2.5 | 7.4 | 8.3 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 2.6 | 4.3 | 5.9 | 2.4 | 6.4 | 7.0 | ns |

 Table 9.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

| Symbol | Parameter | Conditions | | 25 °C | | | -4 | Unit | | |
|----------------|-------------------------------|--|-----|-------|--------|-----|-----|----------------|-----------------|----|
| | | | | Min | Typ[1] | Max | Min | Max (85 °C) | Max (125 °C) | |
| $T_{amb} = 25$ | 5 °C | | | | | , | | • | | |
| C_{PD} | power dissipation capacitance | $f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$ | [3] | | | | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | | - | 2.5 | - | - | - | - | pF |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | | - | 2.7 | - | - | - | - | pF |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | | - | 2.8 | - | - | - | - | pF |
| | | V_{CC} = 1.65 V to 1.95 V | | - | 2.9 | - | - | - | - | pF |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | 3.4 | - | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | - | 4.0 | - | - | - | - | pF |

- [1] All typical values are measured at nominal V_{CC}.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12. Waveforms

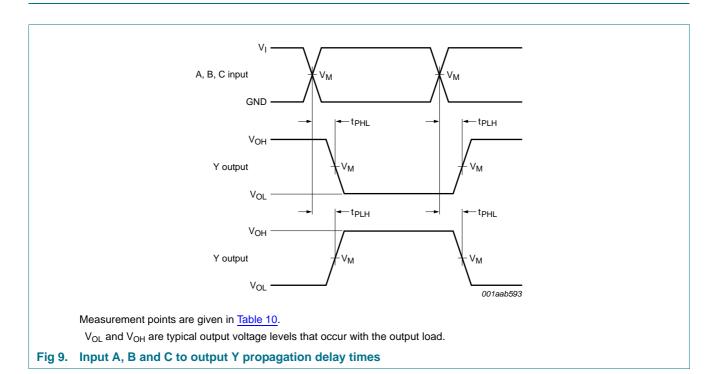
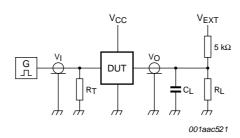


Table 10. Measurement points

| Supply voltage | Output | Input | | | |
|-----------------|---------------------|---------------------|-----------------|-------------|--|
| V _{CC} | V _M | V _M | VI | $t_r = t_f$ | |
| 0.8 V to 3.6 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V _{CC} | ≤ 3.0 ns | |



Test data is given in Table 11.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 10. Load circuitry for switching times

Table 11. Test data

| Supply voltage | Load | | V _{EXT} | | |
|-----------------|------------------------------|------------------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V _{CC} | CL | R _L [1] | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF and 30 pF | 5 k Ω or 1 M Ω | open | GND | $2 \times V_{CC}$ |

[1] For measuring enable and disable times R_L = 5 $k\Omega$, for measuring propagation delays, setup and hold times and pulse width R_L = 1 $M\Omega$.

13. Package outline

Plastic surface-mounted package; 6 leads

SOT363

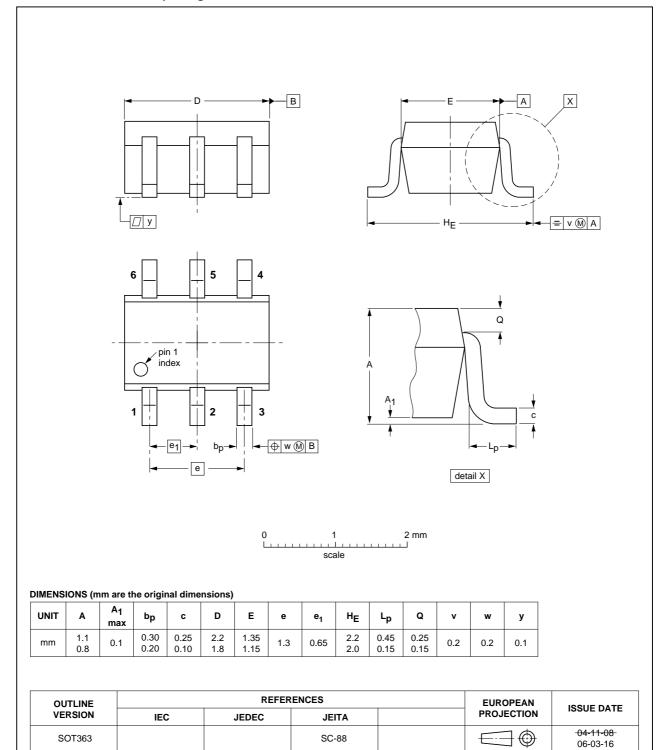


Fig 11. Package outline SOT363 (SC-88)

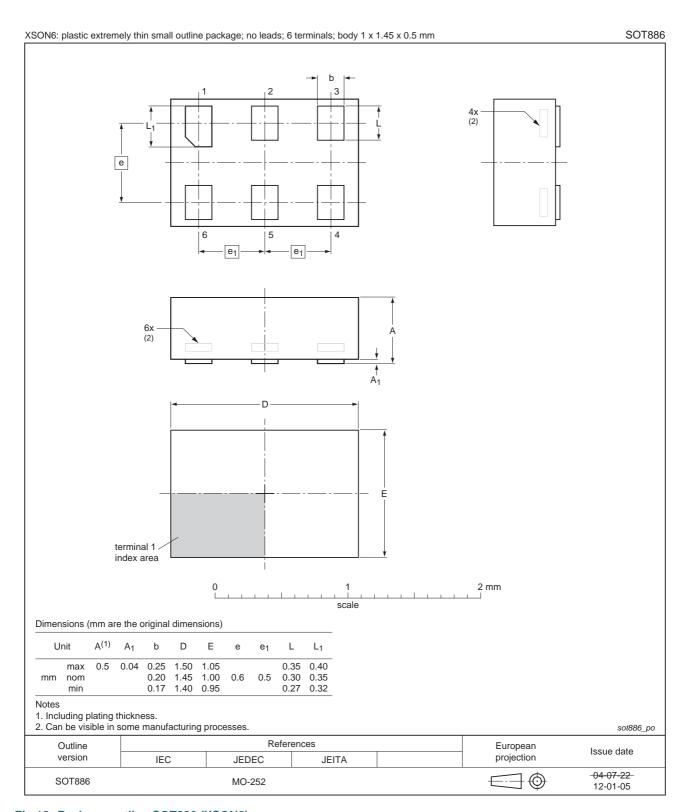


Fig 12. Package outline SOT886 (XSON6)

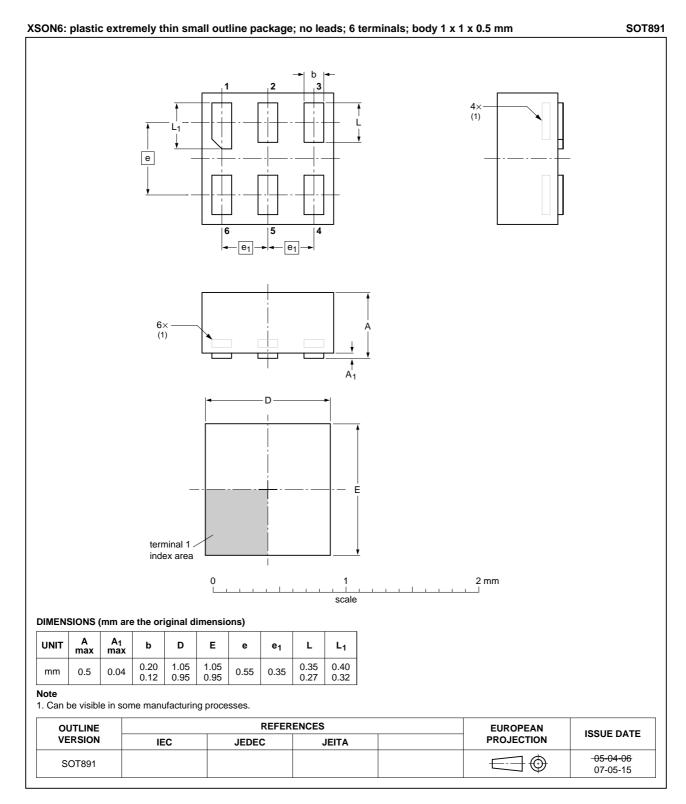


Fig 13. Package outline SOT891 (XSON6)

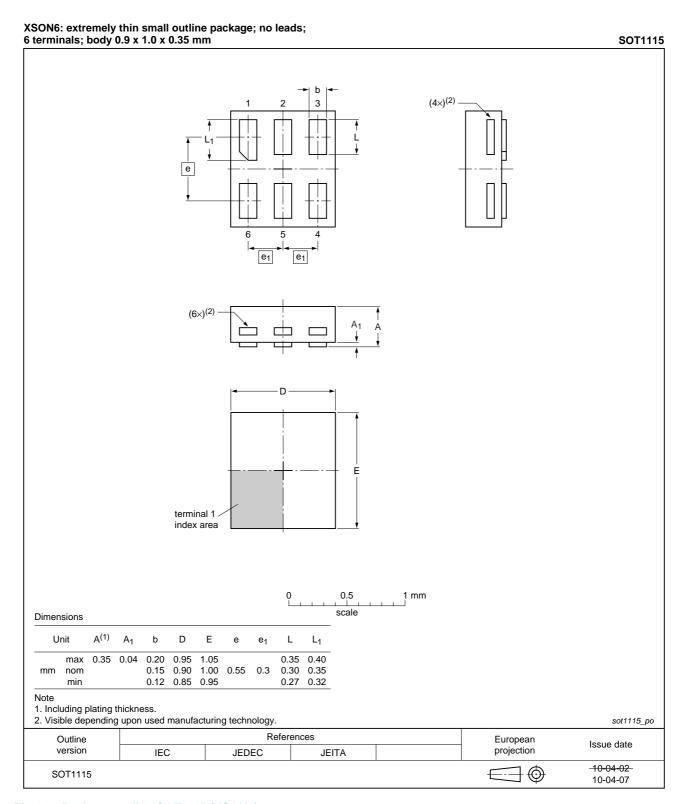


Fig 14. Package outline SOT1115 (XSON6)

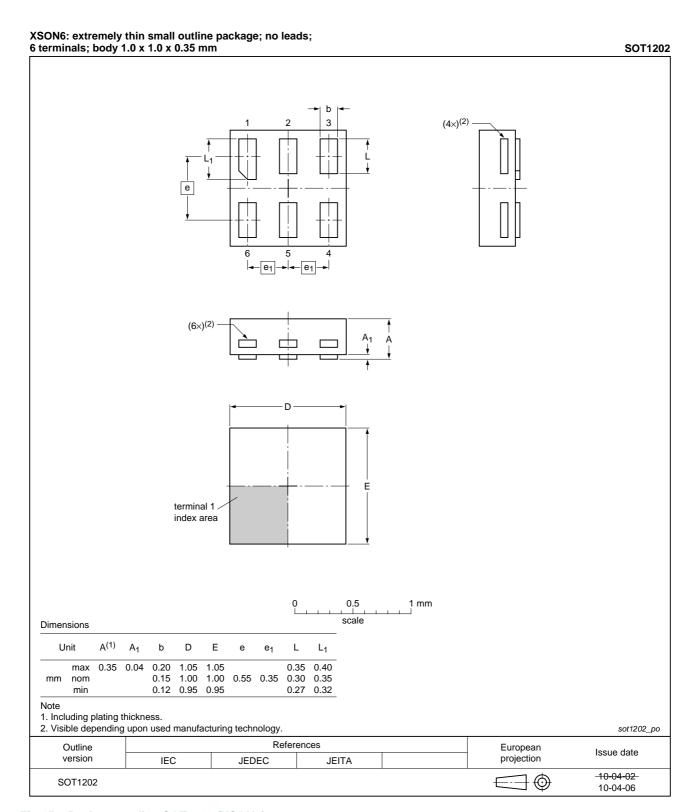


Fig 15. Package outline SOT1202 (XSON6)

14. Abbreviations

Table 12. Abbreviations

| Acronym | Description |
|---------|-------------------------|
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |

15. Revision history

Table 13. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|---------------------------------|--------------------------------------|------------------|-----------------|
| 74AUP1G0832 v.5 | 20120622 | Product data sheet | - | 74AUP1G0832 v.4 |
| Modifications: | Package out | line drawing of SOT886 (<u>Figu</u> | re 12) modified. | |
| 74AUP1G0832 v.4 | 20111115 | Product data sheet | - | 74AUP1G0832 v.3 |
| Modifications: | ons: • Legal pages updated. | | | |
| 74AUP1G0832 v.3 | 20101005 | Product data sheet | - | 74AUP1G0832 v.2 |
| 74AUP1G0832 v.2 | 20090703 | Product data sheet | - | 74AUP1G0832 v.1 |
| 74AUP1G0832 v.1 | 20061108 | Product data sheet | - | - |

16. Legal information

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| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
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